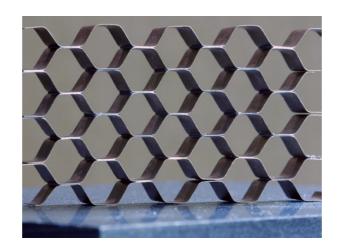
# Cellular Shape Memory Alloy Structures: Experiments & Modeling



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August 1, 2012





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#### Outline

- Background
- Honeycomb specimen fabrication
- Honeycomb characterization
- SMA bending



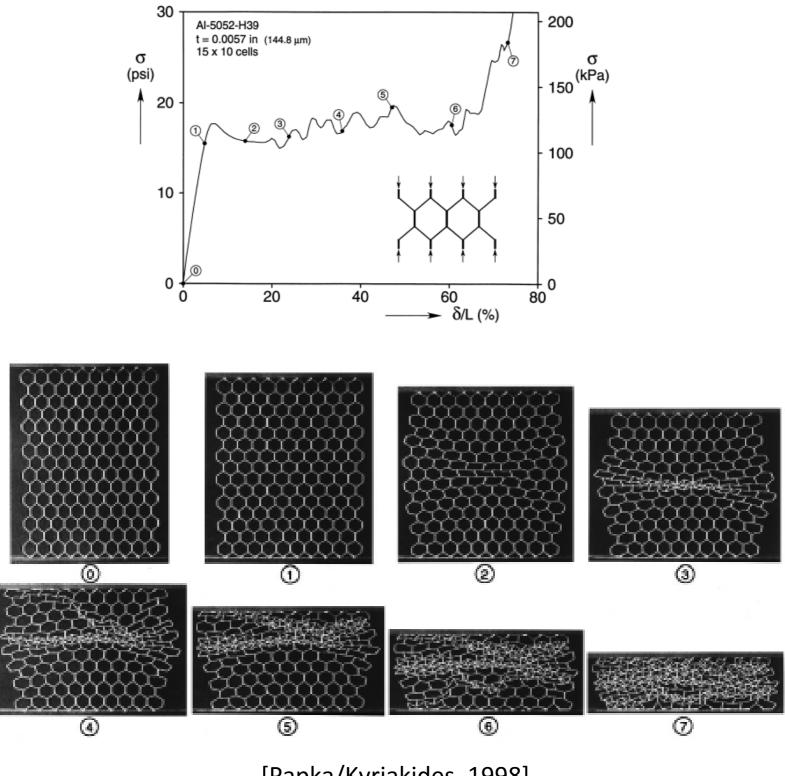


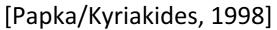
# Background





#### Compression of Al honeycomb

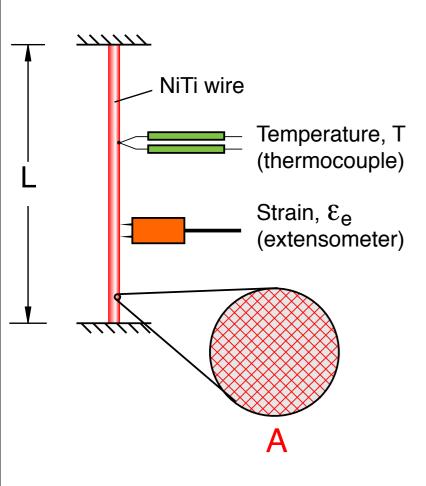


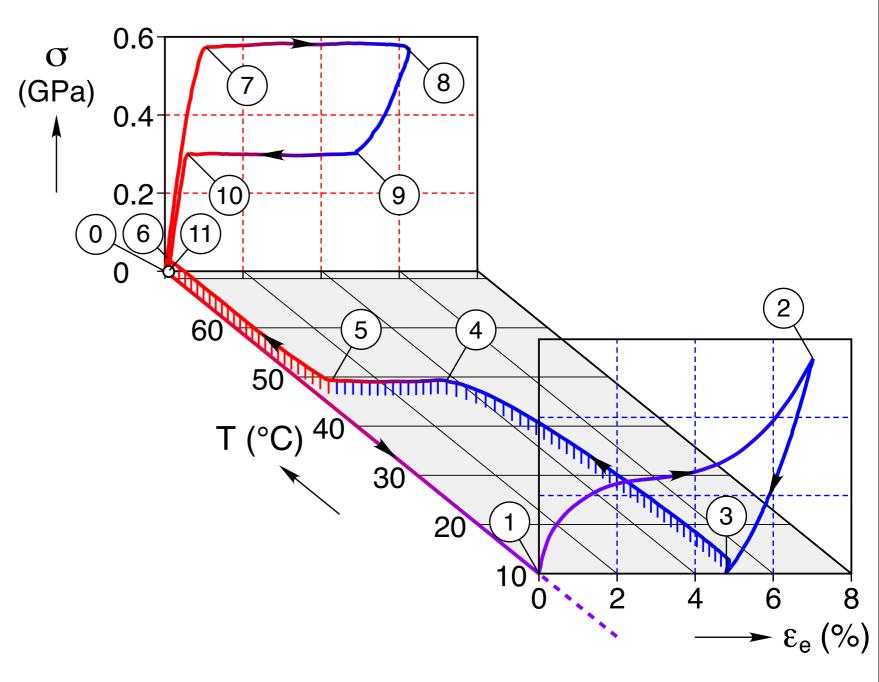






#### Nitinol (SM) wire: shape memory & superelasticity



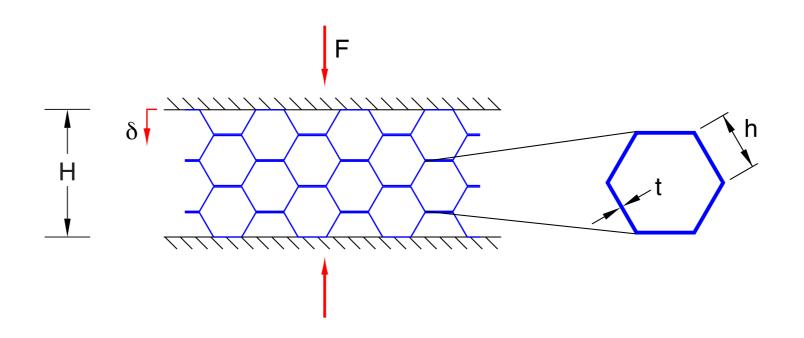


Shape memory & superelasticity





#### Thin-walled honeycomb: scaling laws



relative density

$$\frac{
ho^*}{
ho_{
m s}} \propto \frac{t}{h}$$

global/local bending strain

$$\frac{|\varepsilon_{\rm dense}^*|}{\varepsilon_{\rm s,max}} \propto \frac{t}{h}$$

global/local plateau stress

$$\frac{|\sigma_0^*|}{\sigma_{\mathrm{s},0}} \propto \left(\frac{t}{h}\right)^2$$

global/local modulus

$$\frac{E^*}{E_{\mathrm{s}}} \propto \left(\frac{t}{h}\right)^3$$

[Gibson/Ashby, 1997]

## Comparison of Aluminum & NiTi honeycomb for same recoverable global strain

Property	Al	NiTi	NiTi/Al
$arepsilon_{ ext{dense}}^*$	-50%	-50%	1
$arepsilon_{ ext{s,max}}$	0.5%	5%	10
t/h	$10^{-2}$	$10^{-1}$	10
$ \sigma_0^* /\sigma_{ m s,0}$	$10^{-4}$	$10^{-2}$	100
$E^*/E_{ m s}$	$10^{-6}$	$10^{-3}$	1000





#### Advantages of SMA honeycombs

# Combine benefits of light-weight cellular structures with Shape Memory Alloy (SMA) adaptive behavior

#### Metallic honeycombs

- Low density
- High specific stiffness
- Large specific energy absorption

#### Combination

Amplified strain recovery

5% **⇒** 50%

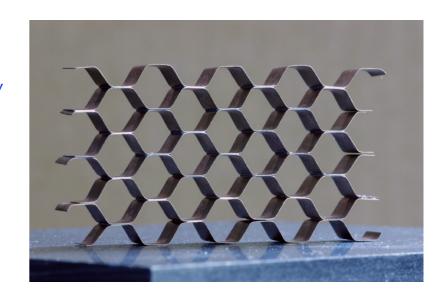
Reduced thermal lag

 $\tau \rightarrow \tau / 10$ 





- Shape memory effect & superelasticity
- High strength, ductility,
- Corrosion resistance, biocompatibility



NiTi hexagonal honeycomb (5.7% dense, 0.37 g/cc)





#### Potential applications of NiTi Cellular Structures

#### Overload protection

- Amplified superelasticity, reusable energy absorber
- Lightweight, resilient, damage tolerant

#### Vibration isolation

Adaptive damping

#### Thermal actuators & adaptive structures

Improved response time, amplified stroke

#### Thermal & acoustic management

Adaptive thermal conductivity & acoustic impedance

#### Biomedical implants & devices

Lightweight, sparse, tailorable properties, deployable





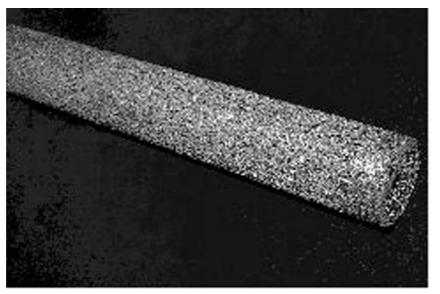
### Fabrication & Metallurgy



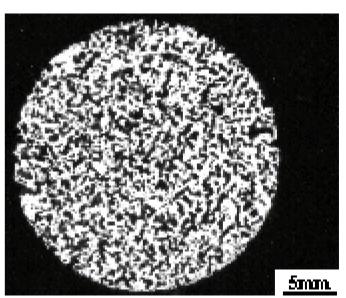


#### Prior Attempts: Powder Metallurgy

#### **Porous SMAs**

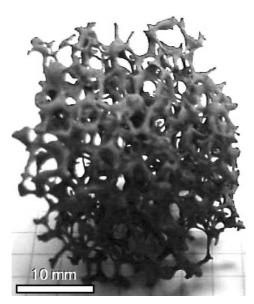


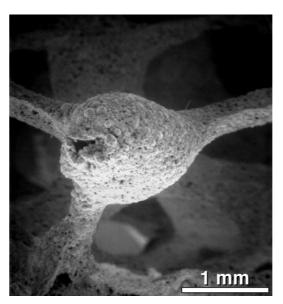
50% dense NiTi bar hot isostatic pressing of elemental powders [Naval Research Lab, V. DeGiorgi]



40% dense NiTi bar combustion synthesis [Li Rong, China]

SMA foam





5% dense NiTi open-cell foam
Powder process with sacrificial precursor
[Grummon/Shaw, 2002]





#### Technological Barrier Overcome

#### Long-standing difficulty:

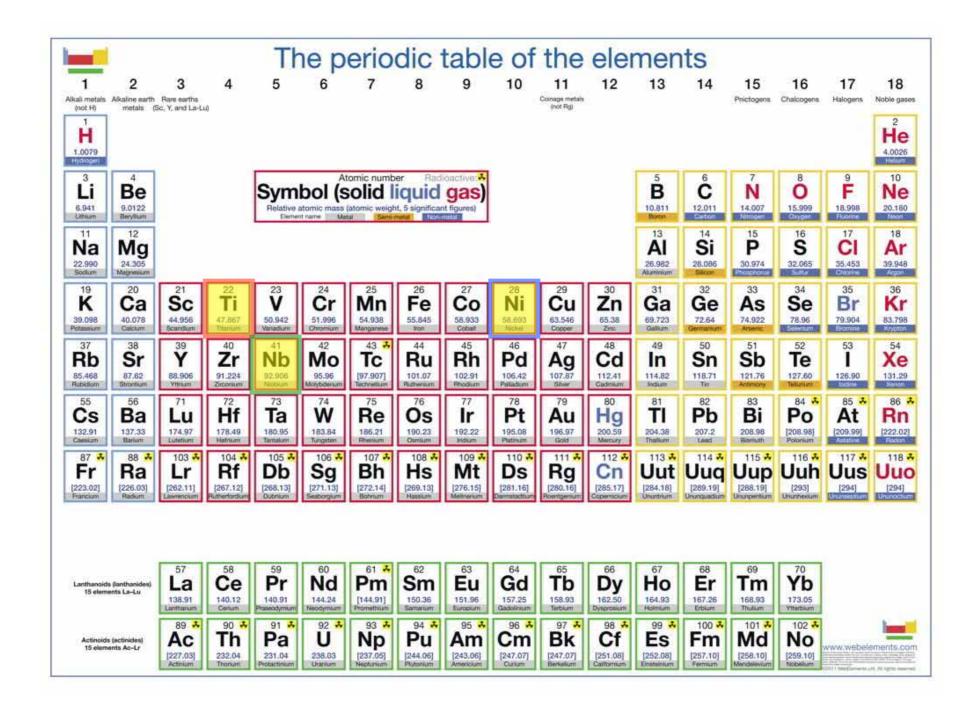
- Joining NiTi to itself or anything else
- Usually requires mechanical attachment/crimping
- Gluing is a very low strength option

#### Metallurgical bonds:

- Sensitive to interstitial contaminants (C, O, N).
- Laser welding in inert gas
  - Tricky (& proprietary), but some recent success.
  - Requires line-of-sight access.
- Soldering
  - Requires very aggressive fluxes to remove Ti-oxides.
  - Low strength
- Nb-reactive bonding (our process)
  - Discovered in 2004
  - Self-fluxing
  - Strong, ductile joints
  - Vanadium also works well



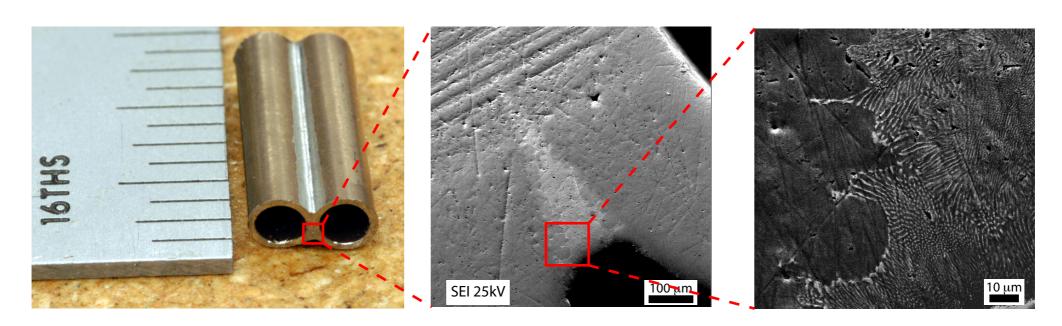




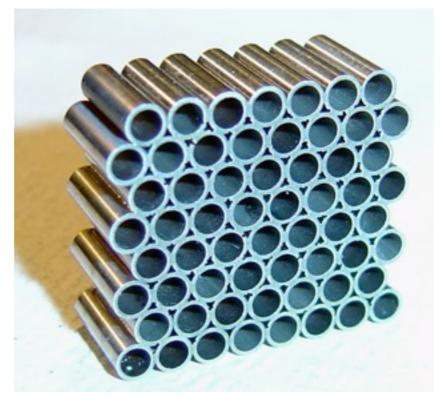




#### Discovery of a Nb-based braze for joining wrought NiTi



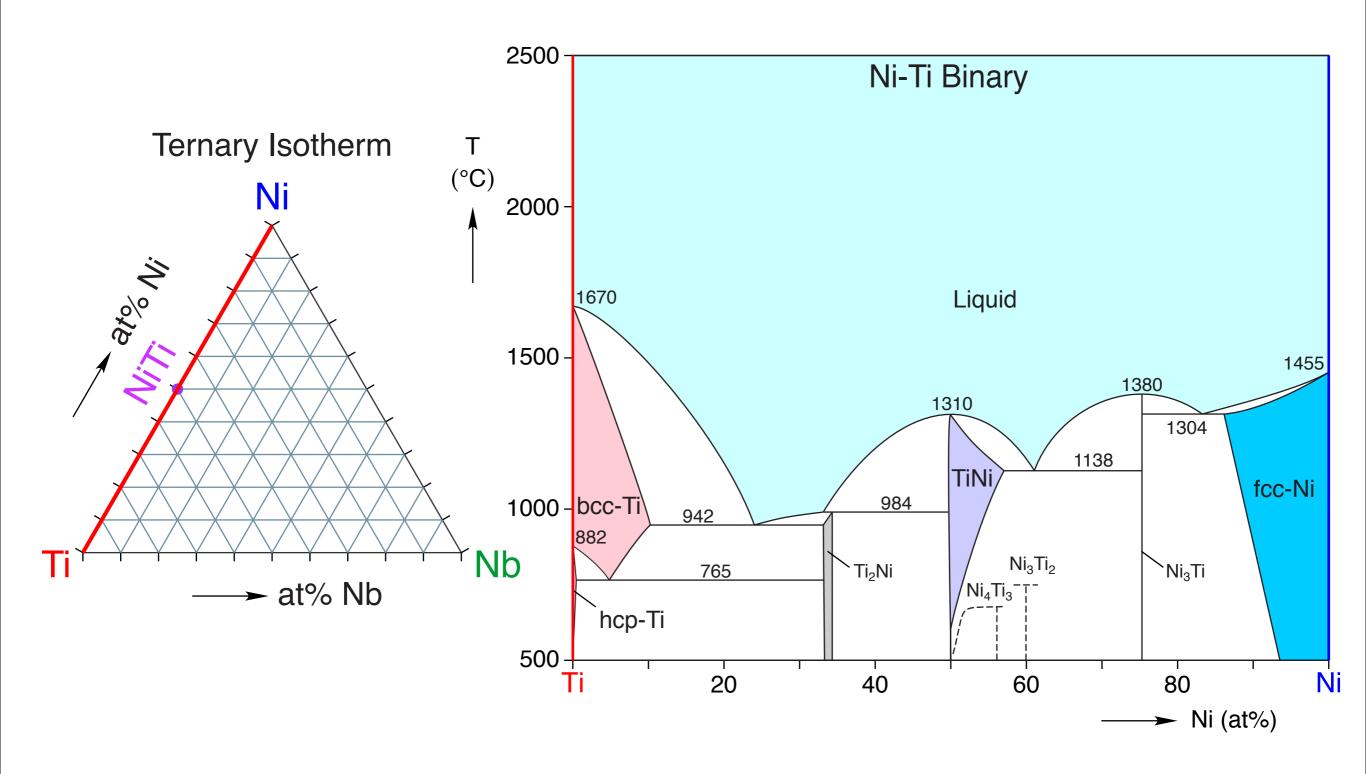
[Shaw/Grummon (UM/MSU) U.S. patent 7,896,222, issued March 1, 2011]



60 NiTi-tube array (32 % dense)

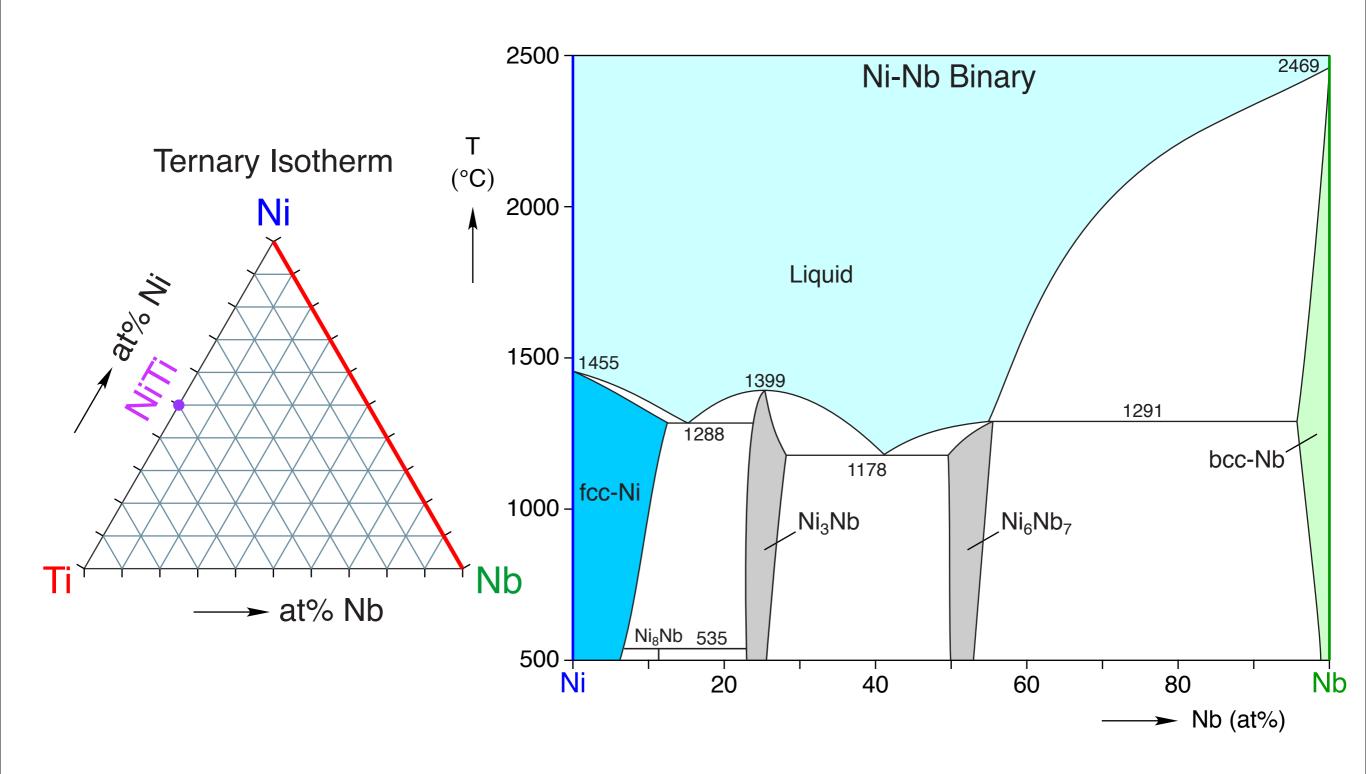






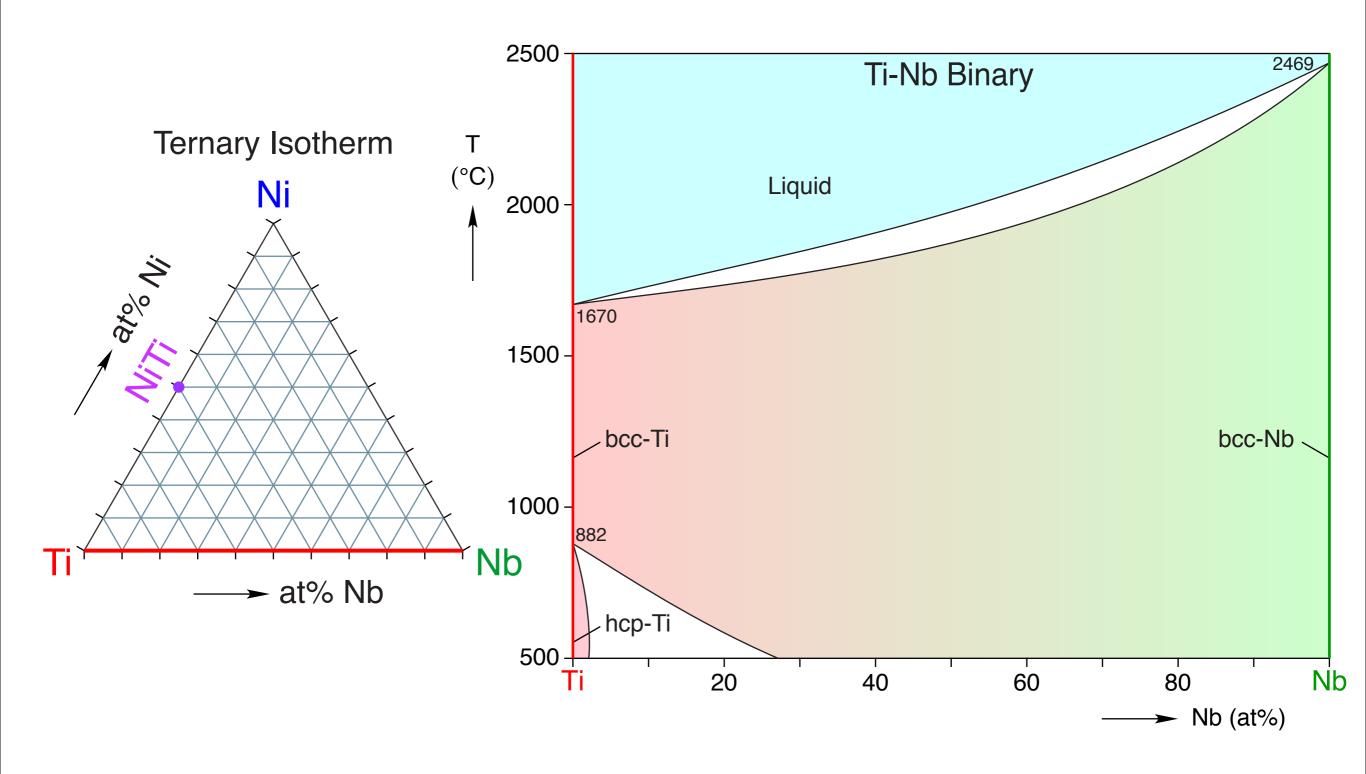






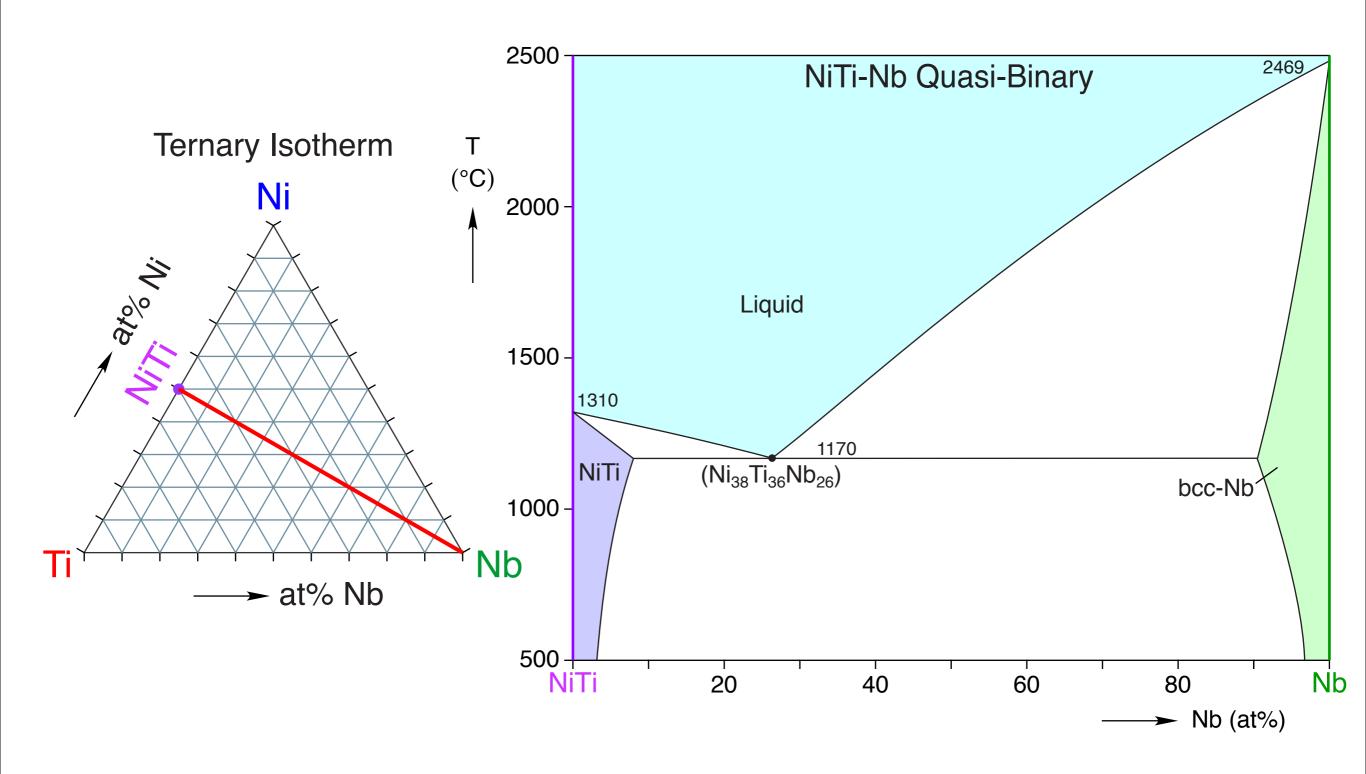








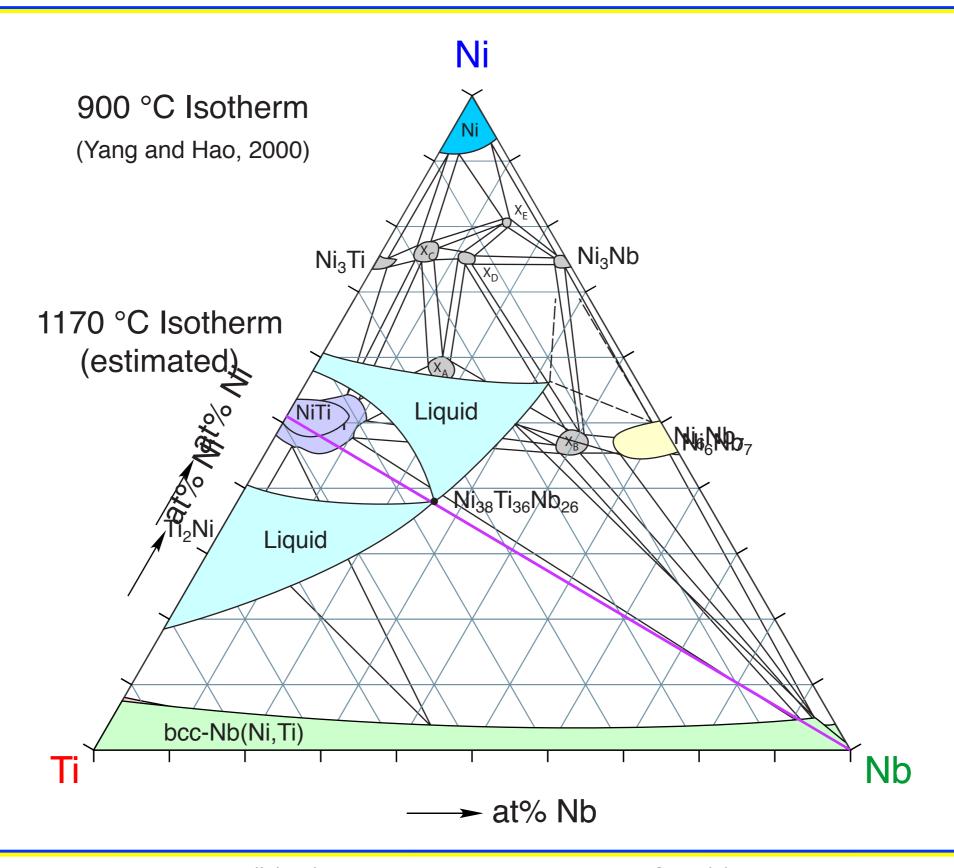








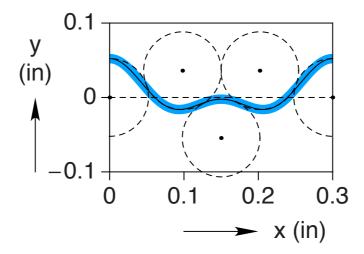
#### **Quasi-binary Eutectic**





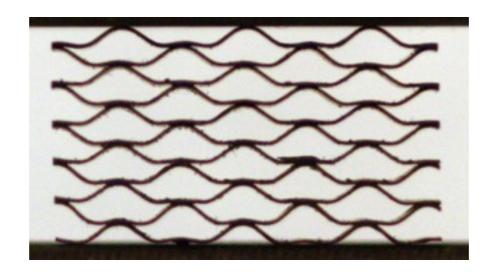


#### **Fabrication Procedure**



Shape-set of corrugated strips (500 °C)

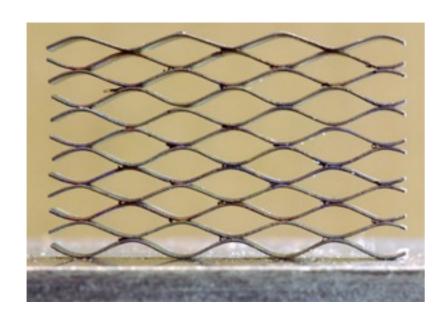
- 1. Corrugate SMA strips at 500 °C by shape set die
- 2. Lay up corrugation layers & Nb foils
- 3. Vacuum furnace at 1170 °C, 5 min
- 4. Age at 500 °C, 10 min

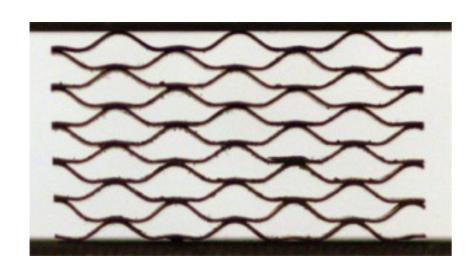




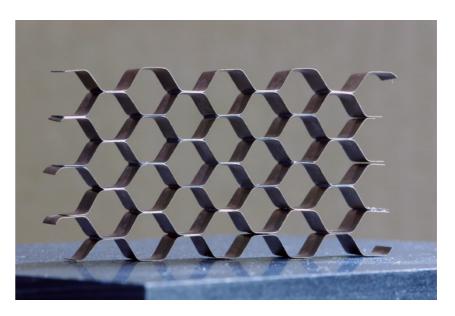


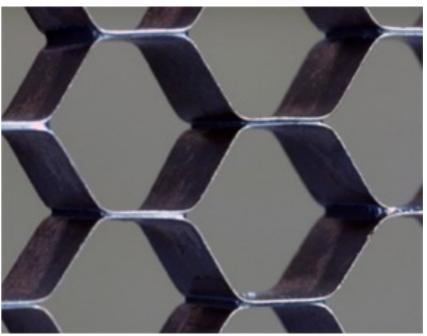
#### Low-density NiTi cellular specimens





NiTi wavy corrugations





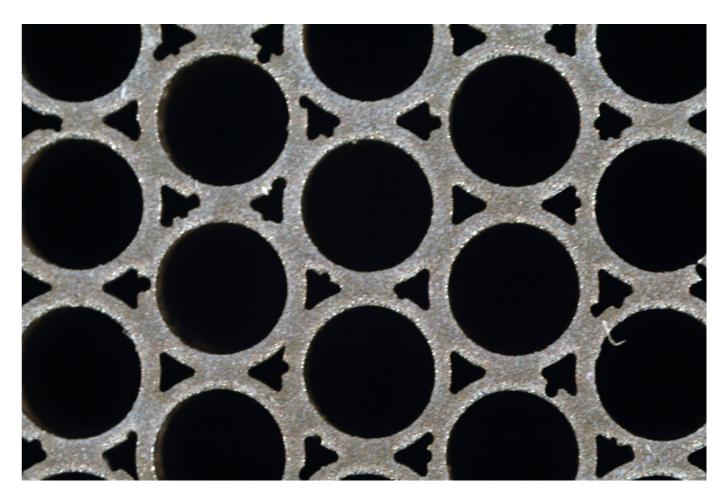
NiTi hexagonal honeycomb (5.7% dense, 0.37 g/cc)





#### **Aggressive Reaction**

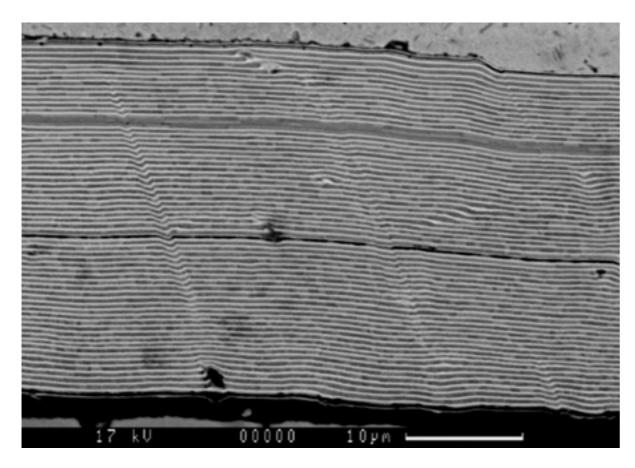








#### Advanced Braze Process Development



20 microns

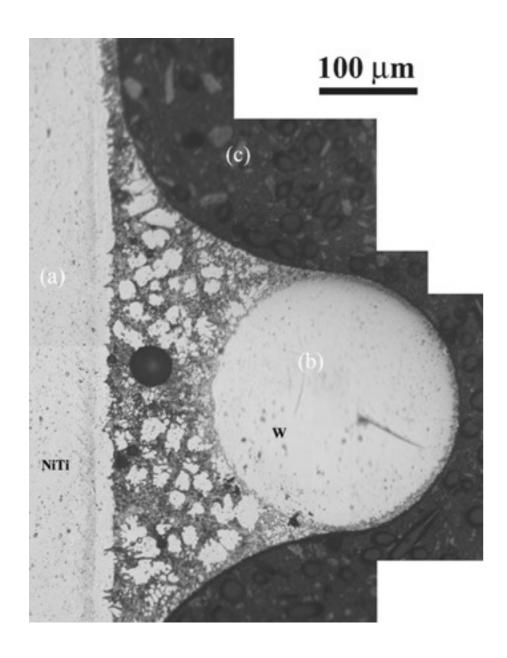
NiTi-Nb multilayer braze foil cross-section (127 layers, 34 micron thickness total)

Braze microstructure using multilayer foil

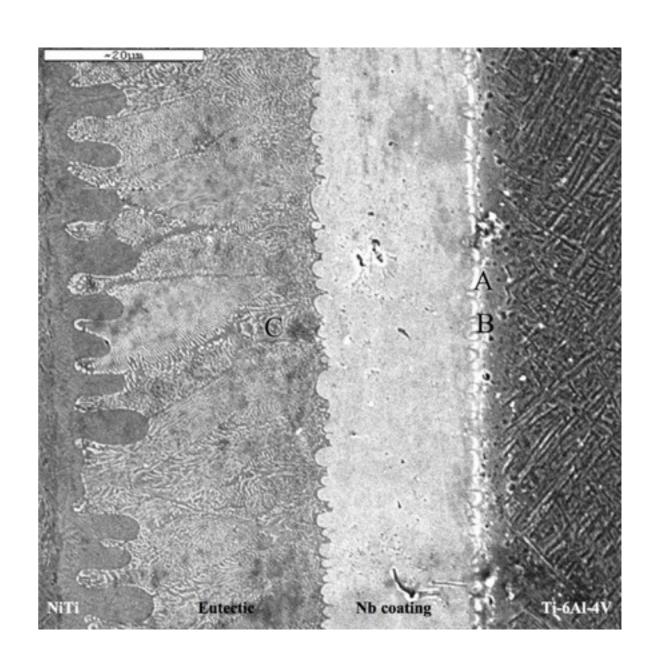




#### Other Heterobonds with NiTi



Pure tungsten (W) wire bonded to NiTi alloy

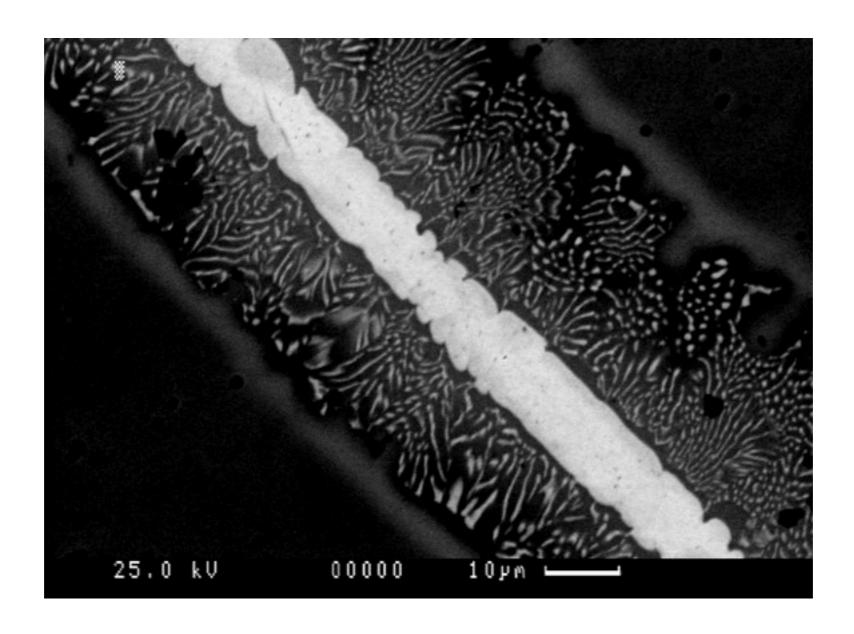


Sputtered Nb layer bonded between NiTi and Ti-6Al-4V





#### Possible Braze for High-temperature SMAs



Braze Joint between two wrought pieces of a Ni<sub>24.5</sub>Pd<sub>25</sub>Ti<sub>50.5</sub> HTSMA (HTSMA from R. Noebe's group, NASA Glenn Research Center)





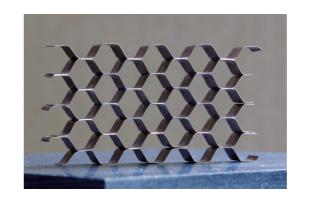
#### Fabrication of SMA cellular structures

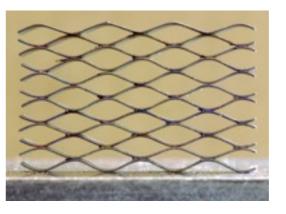
#### **APPROACH:**

- Built-up, low density SMA corrugated structures
- Commercially-available wrought NiTi materials
- Nb-based brazing process

#### **ACCOMPLISHMENTS:**

- Fabricated NiTi SMA specimens:
  - hexagonal honeycombs (~ 5% dense)
  - wavy corrugations (~ 5% dense)
  - close-packed tube array (~ 32 % dense)
- Demonstrated robust braze joints:
  - Up to ~800 MPa tensile strength (butt-joints)
- Preserved adaptive properties of NiTi base material
- Improved layup with self-indexing geometry
- Multi-layer foils improve control of braze stoichiometry
- Positive indications that braze process can be used to join other metal alloys and high-temperature SMAs













#### Possible topologies & geometries

